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(12) **United States Design Patent** (10) **Patent No.:** **US D462,262 S**  
**Leja** (45) **Date of Patent:** **\*\* Sep. 3, 2002**

(54) **SHRINK WRAPPED CARTON FOR ELECTRONIC COMPONENT**

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(\*\*) Term: **14 Years**

(21) Appl. No.: **29/133,052**

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(51) **LOC (7) Cl.** ..... **09-03**

(52) **U.S. Cl.** ..... **D9/415**

(58) **Field of Search** ..... D9/414, 415, 418,  
D9/432, 337; D3/201, 273, 905; 206/461-471,  
806, 495, 701, 722, 723, 349

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(57) **CLAIM**

The ornamental design for a shrink wrapped carton for electronic component, as shown.

**DESCRIPTION**

FIG. 1 is a perspective view of a shrink-wrapped package for an electronic component showing my new design.

FIG. 2 is a front view of the package shown in FIG. 1.

FIG. 3 is a rear view of the package shown in FIG. 1.

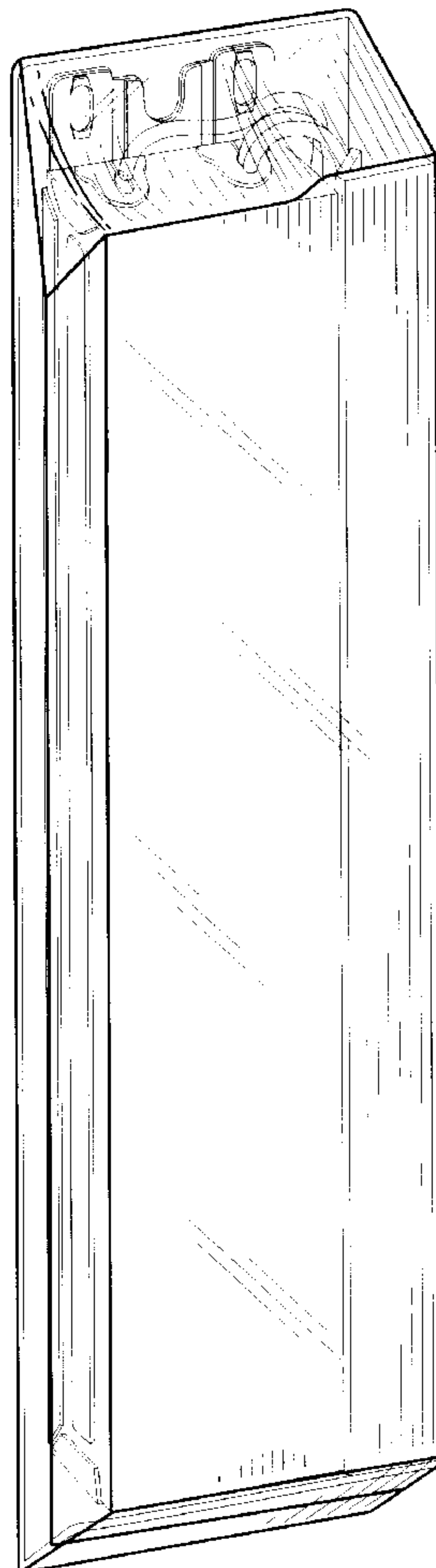
FIG. 4 is a left side view of the package shown in FIG. 1.

FIG. 5 is a right side view of the package shown in FIG. 1.

FIG. 6 is a top view of the package shown in FIG. 1; and,

FIG. 7 is a bottom view of the package shown in FIG. 1.

**1 Claim, 6 Drawing Sheets**





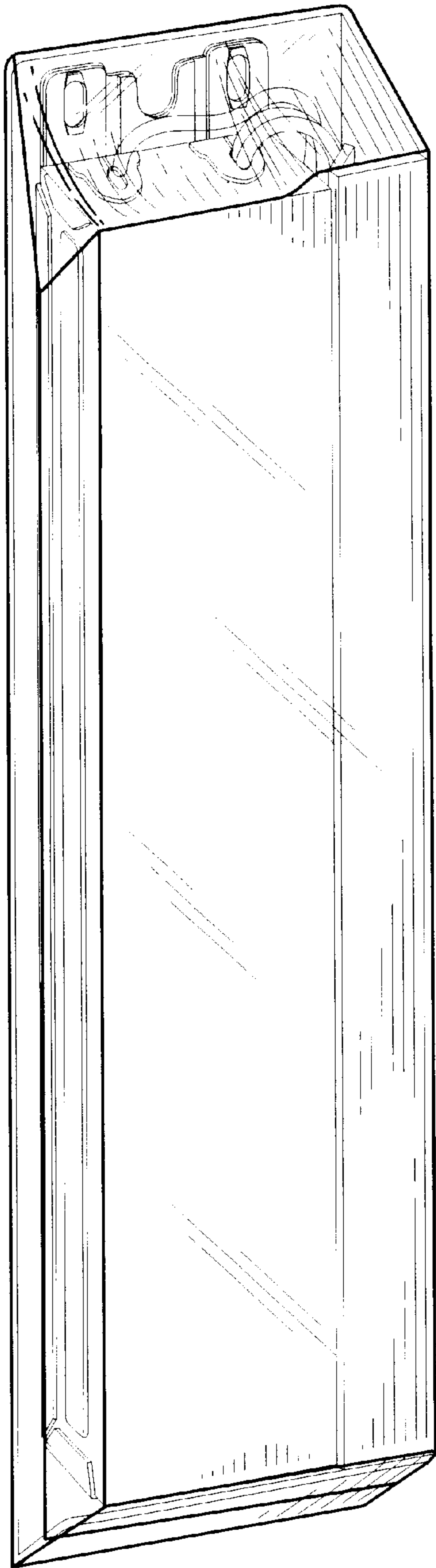


FIG. 1



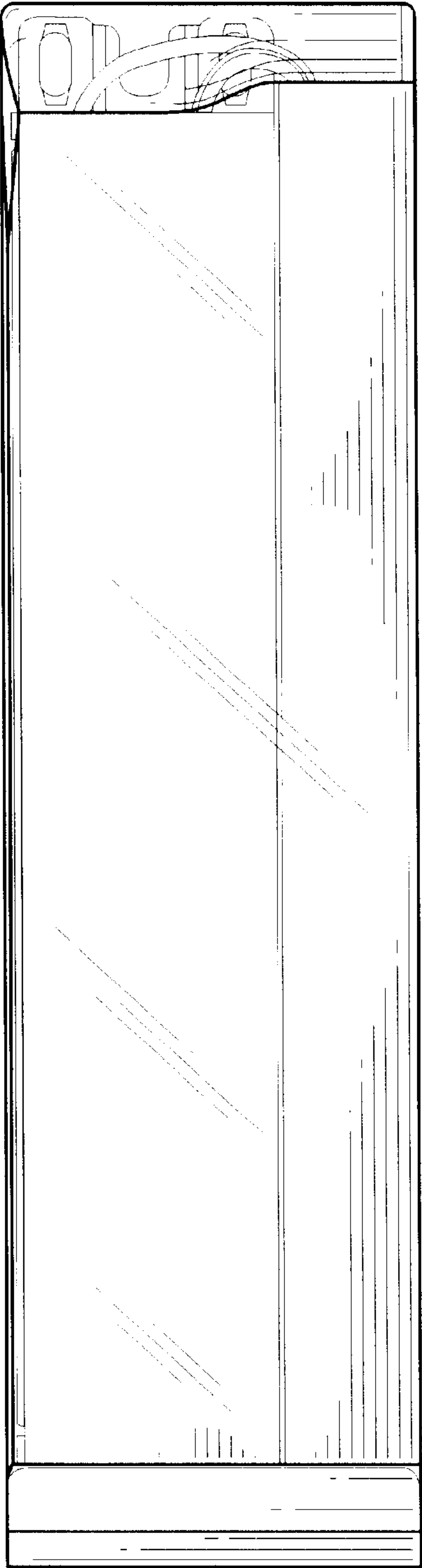


FIG. 2



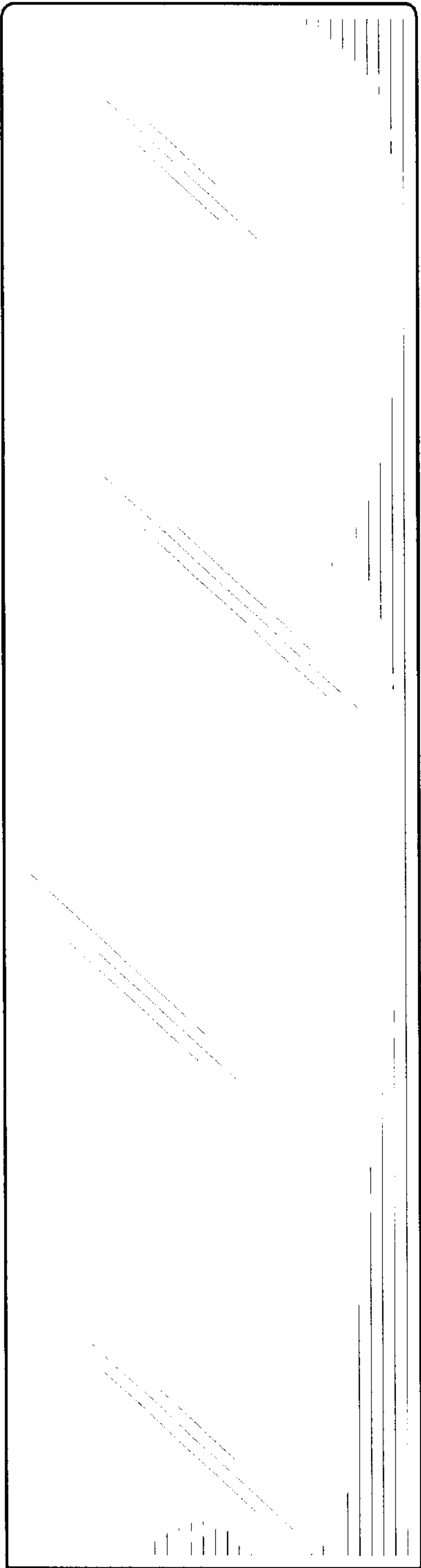


FIG. 3



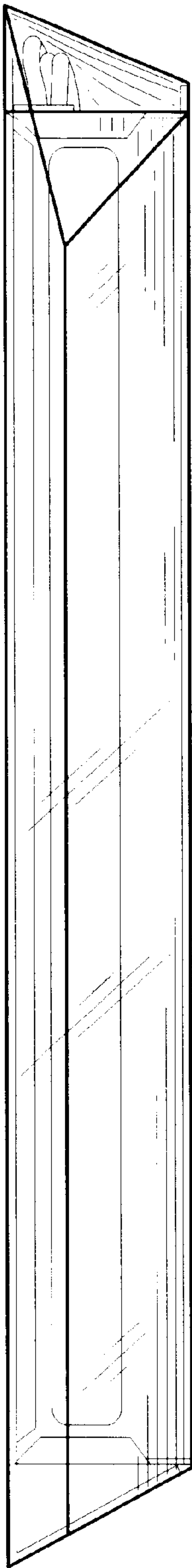


FIG. 4



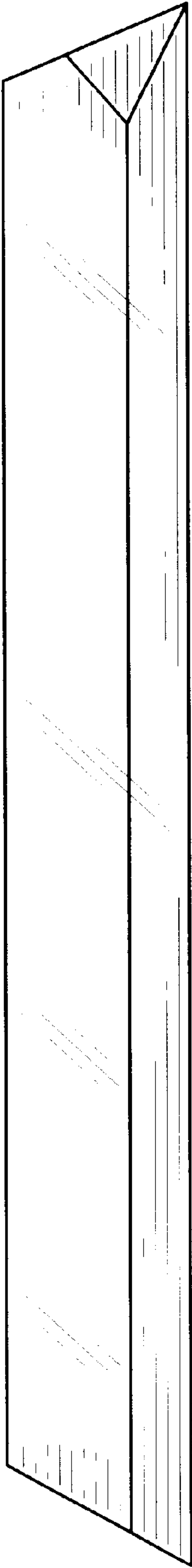


FIG. 5



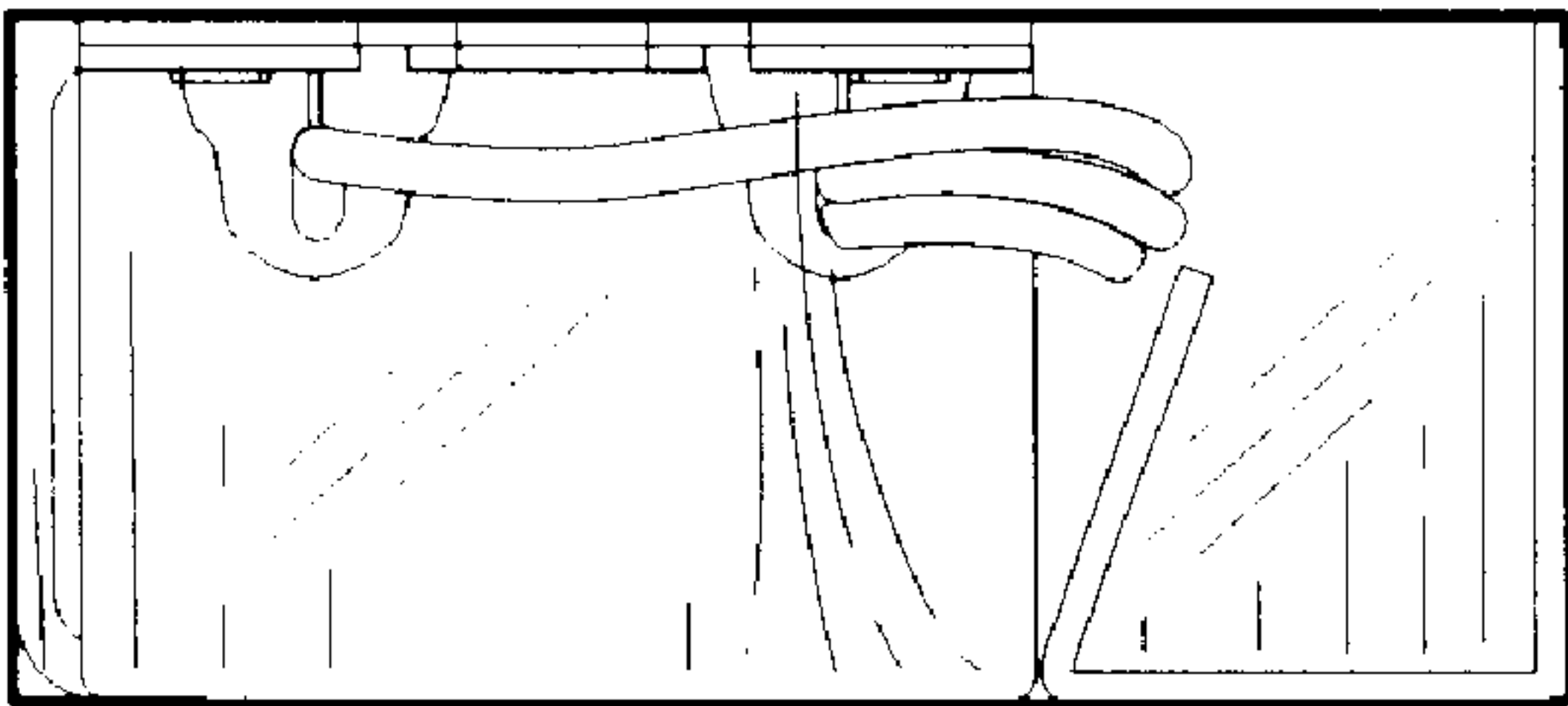


FIG. 6

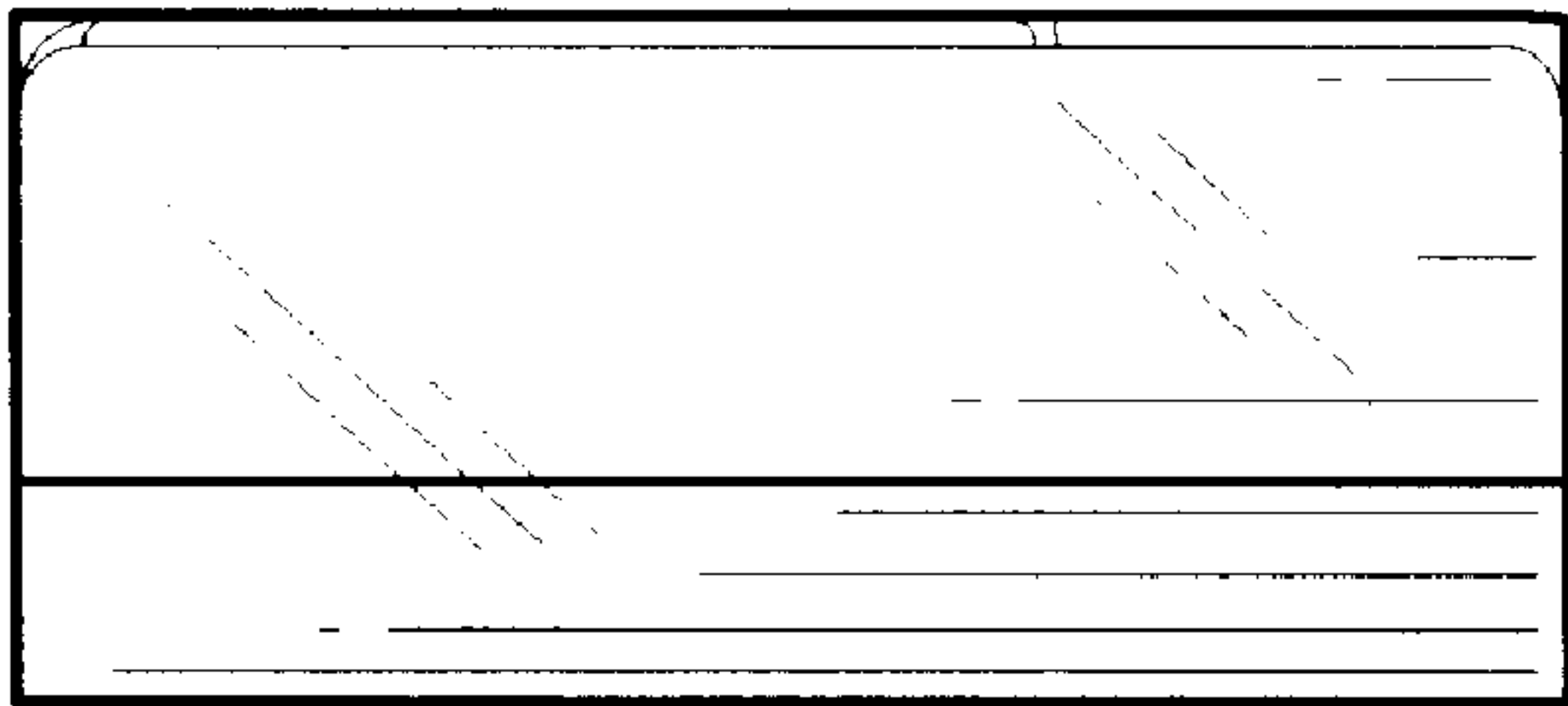


FIG. 7